Lecture 8w: Process Modules IV

<u>Lecture 8</u> : Process Modules IV
· Announcements:
· HW #2: Due next Tuesday
<ul> <li>No office hours for me on Wednesday, 9/21, due to the BSAC Industrial Advisory Board Meeting</li> </ul>
· Change of plans:
♦ There will be lecture Thursday, 9/22, during the normal time period
♥It might be shortened by 10 minutes
· No lecture on Thursday, 9/29
Make-up lecture: Friday, 9/30, 3-4:30, 293     Cory
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· <u>Today</u> :
· Finish process modules from Module 4
<ul> <li>Reading: Senturia Chpt. 3, Jaeger Chpt. 11, Handout: "Surface Micromachining for Microelectromechanical Systems"</li> </ul>
∜Lecture Topics:
⋄Polysilicon surface micromachining
♥ Polysilicon surface micromachining ♥ Stiction
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∜ Stiction
∜ Stiction ∜ Residual stress
<ul><li>♦ Stiction</li><li>♦ Residual stress</li><li>♦ Topography issues</li></ul>
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EE C245/ME C218: Introduction to MEMS CTN 9/20/11

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